



**THE DATASHEET OF
PS7200U-1A-F3-A**



**4-PIN SOP LOW OFF-STATE LEAKAGE CURRENT
1-ch Optical Coupled MOS FET**

-NEPOC Series-

DESCRIPTION

The PS7200U-1A is a low output capacitance solid state relay containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

It is suitable for high-frequency signal control, due to its extremely low off-state leakage current, low output capacitance, and high-speed turn-on time.

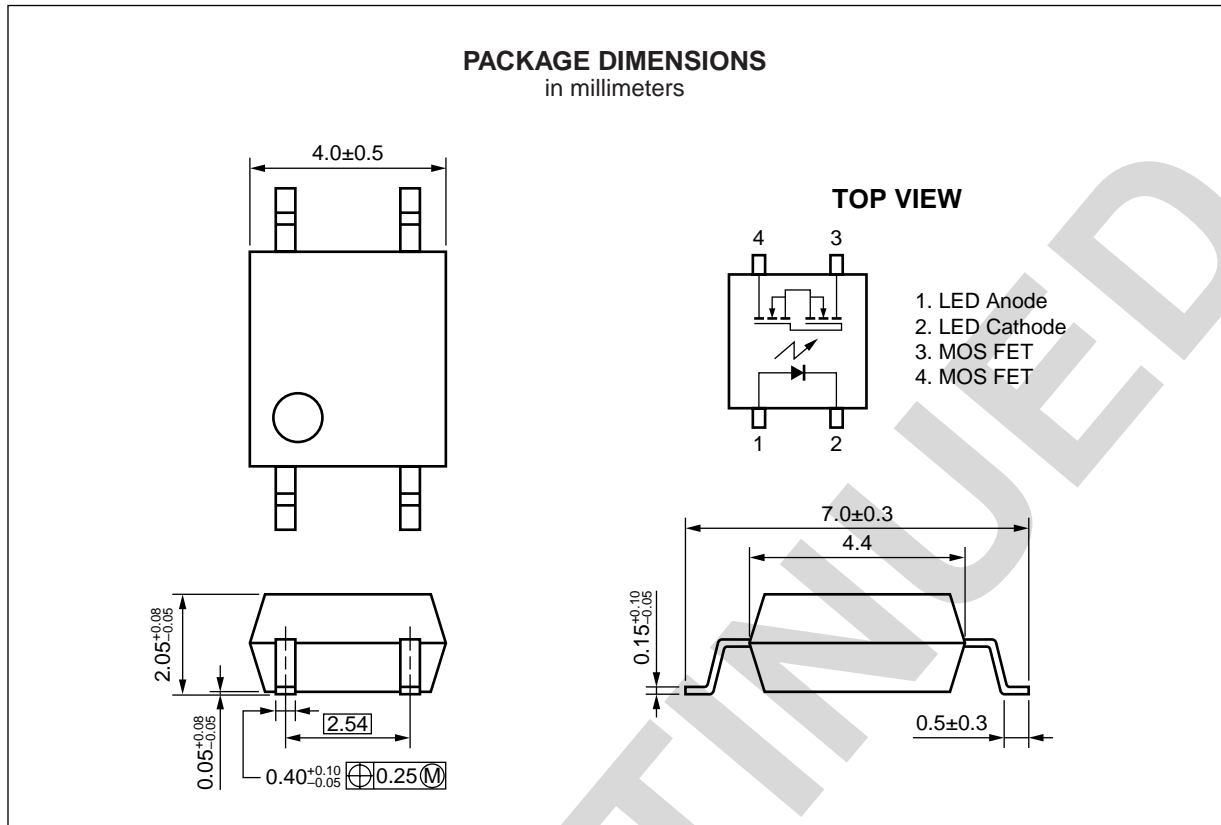
FEATURES

- Low off-state leakage current ($I_{Loff} = 0.1 \text{ nA TYP.}$)
- Break down voltage ($V_L = 80 \text{ V}$)
- High-speed turn-on time ($t_{on} = 0.05 \text{ ms TYP.}$)
- Low output capacitance ($C_{out} = 2.3 \text{ pF TYP.}$)
- $C \times R$ ($C \times R = 40 \text{ pF} \cdot \Omega$)
- 1 channel type (1 a output)
- Designed for AC/DC switching line changer
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- Low offset voltage
- Ordering number of taping product : PS7200U-1A-E3, E4: 900 pcs/reel
: PS7200U-1A-F3, F4: 3 500 pcs/reel
- Pb-Free product

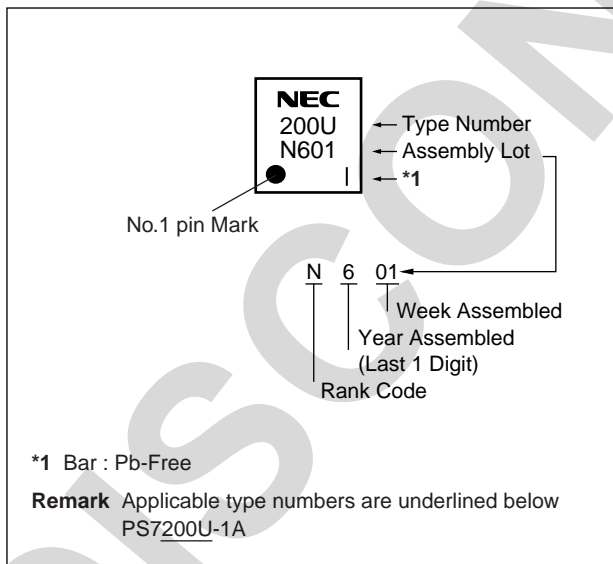
APPLICATIONS

- Measurement equipment

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<R> **MARKING EXAMPLE (LASER MARKING)**



<R> **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style
PS7200U-1A	PS7200U-1A-A	Pb-Free	Magazine case 100 pcs
PS7200U-1A-E3	PS7200U-1A-E3-A		Embossed Tape 900 pcs/reel
PS7200U-1A-E4	PS7200U-1A-E4-A		
PS7200U-1A-F3	PS7200U-1A-F3-A		Embossed Tape 3 500 pcs/reel
PS7200U-1A-F4	PS7200U-1A-F4-A		

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	I _F	50	mA
	Reverse Voltage	V _R	5.0	V
	Power Dissipation	P _D	50	mW
	Peak Forward Current *1	I _{FP}	1	A
MOS FET	Break Down Voltage	V _L	80	V
	Continuous Load Current	I _L	40	mA
	Pulse Load Current *2 (AC/DC Connection)	I _{LP}	80	mA
	Power Dissipation	P _D	300	mW
Isolation Voltage *3		BV	1 500	Vr.m.s.
Total Power Dissipation		P _T	350	mW
Operating Ambient Temperature		T _A	-40 to +85	°C
Storage Temperature		T _{stg}	-40 to +100	°C

*1 PW = 100 μs, Duty Cycle = 1%

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.
Pins 1-2 shorted together, 3-4 shorted together.

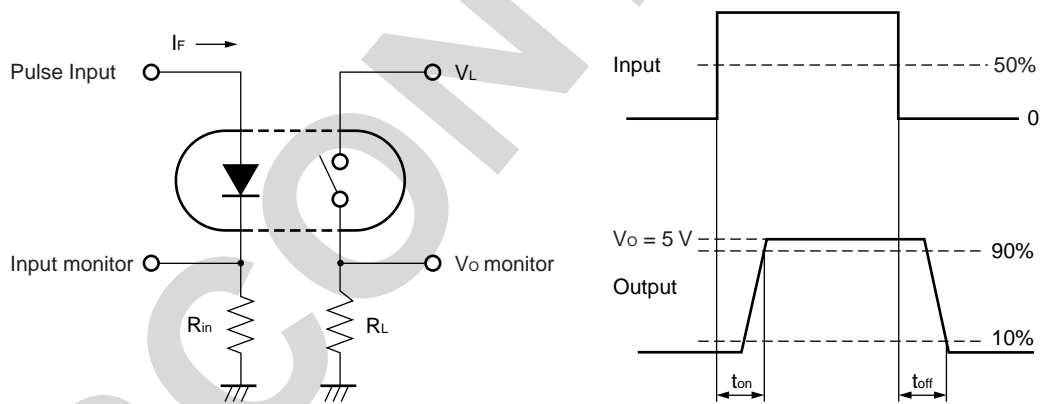
RECOMMENDED OPERATING CONDITIONS (T_A = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	I _F	2	10	20	mA
LED Off Voltage	V _F	0		0.5	V

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 5 mA		1.1	1.3	V
	Reverse Current	I _R	V _R = 5 V		0.01	5.0	μA
MOS FET	Off-state Leakage Current	I _{Loff}	V _D = 80 V		0.1	1.0	nA
	Output Capacitance	C _{out}	V _D = 0 V, f = 1 MHz		2.3	3.5	pF
Coupled	LED On-state Current	I _{Fon}	I _L = ±40 mA			2.0	mA
	On-state Resistance	R _{on}	I _F = 5 mA, I _L = ±40 mA		17	25	Ω
	Turn-on Time ^{*1,2}	t _{on}	I _F = 5 mA, V _L = 5 V, R _L = 500 Ω,		0.05	0.5	ms
	Turn-off Time ^{*1,2}	t _{off}	PW ≥ 0.5 ms		0.15	0.5	
	Isolation Resistance	R _{I-O}	V _{I-O} = 1.0 kV _{DC}	10 ⁹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.3		pF

*1 Test Circuit for Switching Time



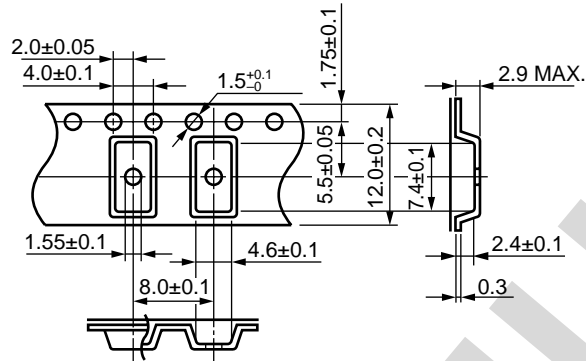
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*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 0.5 ms.

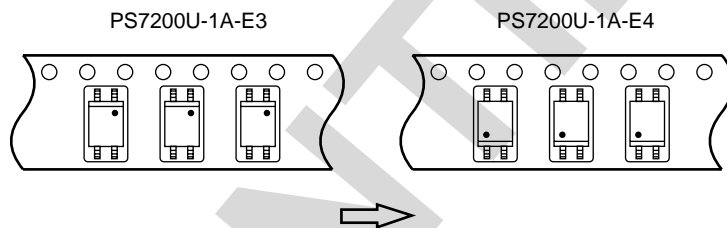
Be aware that when the device operates with an input-pulse width less than 0.5 ms, the turn-on time and turn-off time will increase.

TAPING SPECIFICATIONS (in millimeters)

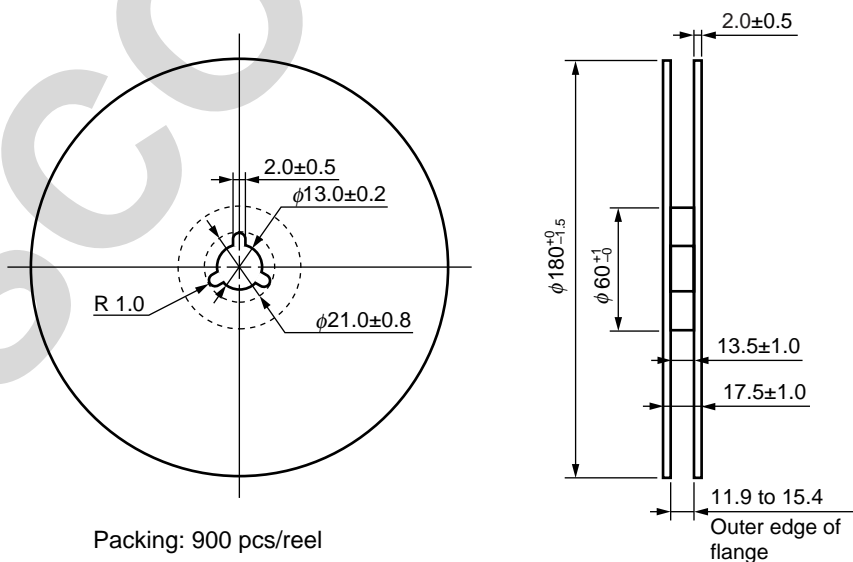
Outline and Dimensions (Tape)



Tape Direction

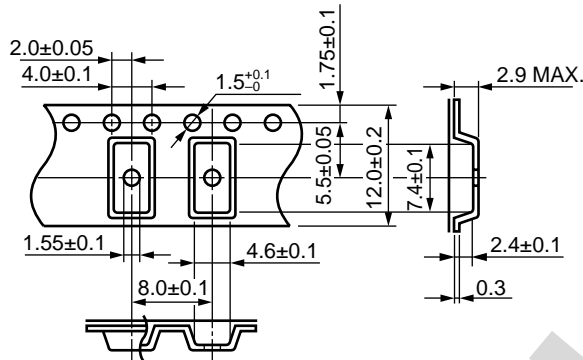


Outline and Dimensions (Reel)

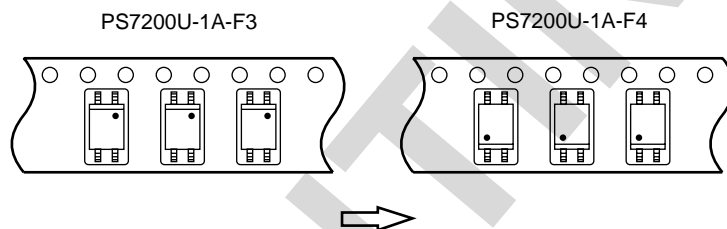


Packing: 900 pcs/reel

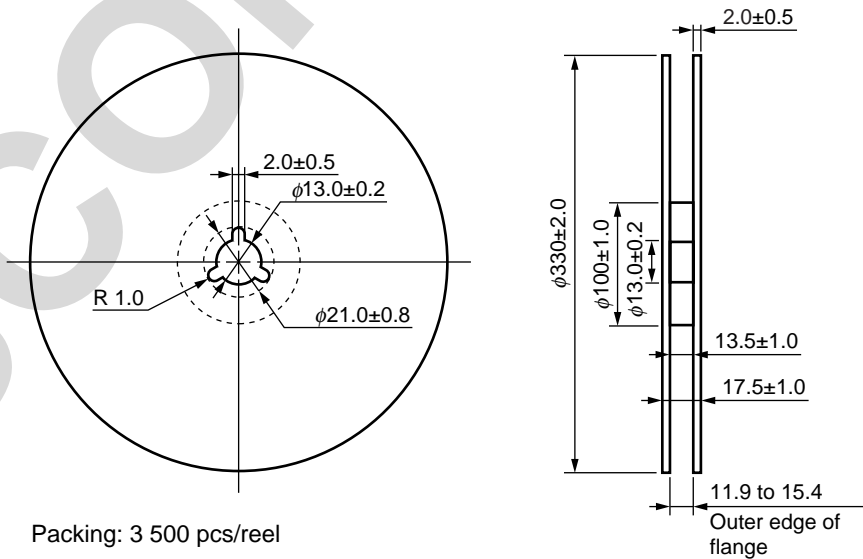
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)

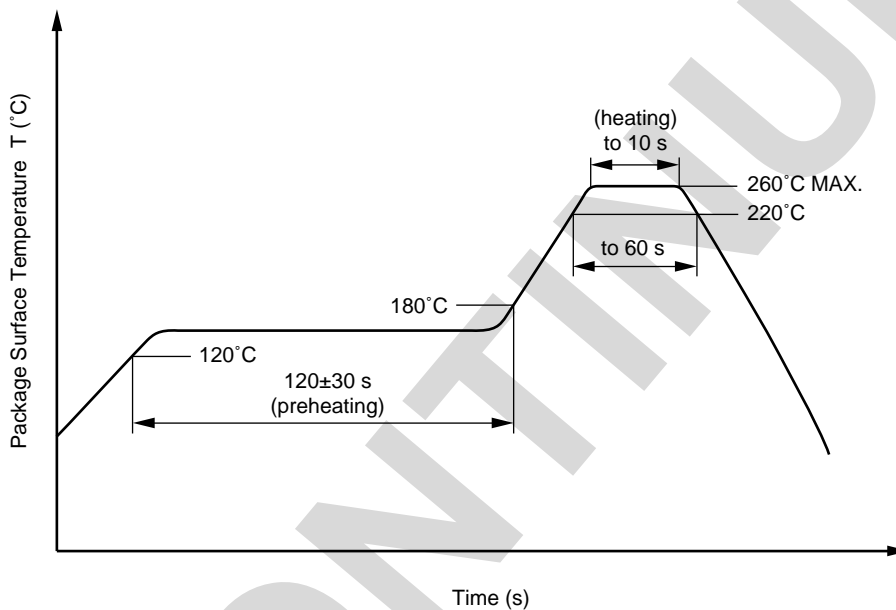


RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

- Fluxes
Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

DISCONTINUED

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